

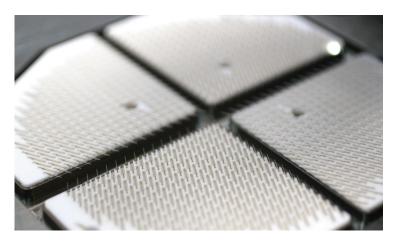
MULTI-SITE PRODUCTION BURN-IN

Production Burn-In

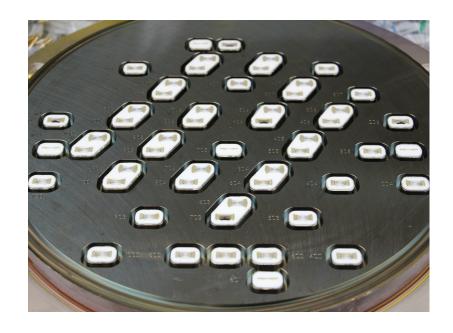
Lights-out high-density full wafer production test

T300 ButtonTiles™ are optimized for high-density, multi-site, long-term, temperature-compensated wafer production burn-in applications. The ceramic tiles match the expansion characteristics of a wafer at high temperatures, so users don't need to constantly monitor in-progress testing.

ButtonTiles[™] can accommodate up to 10,000 probes respectively. The standard operating temperature range is -65° to 300°C standard, with a high temperature option up to 400°C. High voltage up to 3kV with arc-reduction gas-purge options available. With the T300 ButtonTile[™], reliably burn in your entire product wafer.







MULTI-SITE
WAFER LEVEL
RELIABILITY AND
PRODUCTION
BURN-IN

220603r1